

HotChips 19 thanks this year's sponsors:

Platinum Sponsor



Gold Sponsors

cādence™



NEC

Silver Sponsors



Warthman Associates
Technical Writers
www.warthman.com

Additional Sponsors



NVIDIA®

CIRCUIT CELLAR®

THE MAGAZINE FOR COMPUTER APPLICATIONS



Proudly affiliated with





HotChips 19 Organizing Committee



Conference Chair	John Sell, Microsoft
Conference Vice-Chair	Don Draper, Rambus Inc.
CTO	Yusuf Abdulghani, Apple
Registration	Ravi Rajamani, Oracle
	Sujata Ramasubramanian, Intel
Publicity	Kevin Krewell, NVIDIA
	Gail Sachs, Telairity
Local Arrangements - Food	Allen Baum, Intel
Local Arrangements - Facilities	Lance Hammond, Apple
Advertising	Don Draper, Rambus Inc.
	Fely Krewell, Spansion
Webmaster	Alexis Cordova
Finance	Lily Jow, HP
Sponsorship	Amr Zaky, Broadcom
Publications	Gordon Garb, Sun Microsystems, Inc.
	Randall Neff,
Volunteer Coordinator	Charlie Neuhauser, Neuhauser Associates



HotChips 19 Program Committee



Co-Chairs	Rajeevan Amirtharajah, UC, Davis
	John Mashey, Techviser
Committee	Forest Baskett, New Enterprise Associates
	Dileep Bhandarkar, Microsoft
	Doug Burger, University of Texas - Austin
	Norm Jouppi, HP Labs
	Christos Kozyrakis, Stanford University
	John Kubiatowicz, UC, Berkeley
	John Montyrm, NVIDIA
	Chuck Moore, AMD
	Mitsuo Saito, Toshiba
	Alan Jay Smith, UC, Berkeley
	Marc Tremblay, Sun Microsystems
	John Wawrzynek, UC, Berkeley
	Jan-Willem van de Waerd, NXP
	Ralph Wittig, Xilinx



HotChips Steering Committee



	Donald Alpert, Camelback Computer Architecture
	Allen Baum, Intel
	Pradeep Dubey, Intel
	Lily Jow, HP
	John Mashey, Techviser
	Howard Sachs, Telairity Semiconductor
	Alan Jay Smith, UC, Berkeley
Founder	Bob Stewart, SRE



Thanks also to our HotChips Volunteers!



& thanks for publications help to Adrean, Ivan, Mario, and Pam of the Palo Alto FedexKinko's.